

FDMS86101A N-Channel PowerTrench[®] MOSFET 100 V, 60 A, 8 m Ω

Features

- Max $r_{DS(on)}$ = 8 m Ω at V_{GS} = 10 V, I_D = 13 A
- Max $r_{DS(on)}$ = 13.5 m Ω at V_{GS} = 6 V, I_D = 9.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- 100% Rg tested
- RoHS Compliant

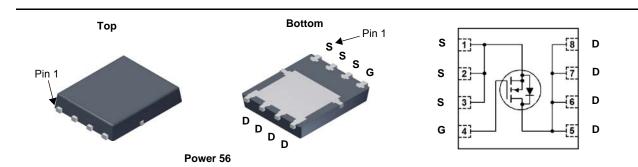


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		60		
	-Continuous (Silicon limited) T _C = 25 °C			81		
	-Continuous	T _A = 25 °C	(Note 1a)	13	Α	
	-Pulsed			180		
E _{AS}	Single Pulse Avalanche Energy (N		(Note 3)	486	mJ	
P _D	Power Dissipation	T _C = 25 °C		104	14/	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/W

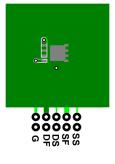
Package Marking and Ordering Information

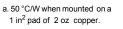
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86101A	FDMS86101A	Power 56	13 "	12 mm	3000 units

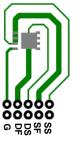
April 2012

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		71		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			800	nA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 13 A		6.3	8	
		V _{GS} = 6 V, I _D = 9.5 A		8.0	13.5	mΩ
		V _{GS} = 10 V, I _D = 13 A, T _J = 125 °C		10.3	13.1	1
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 13 A		53		S
Dynamic C _{iss}	Characteristics Input Capacitance	V 50V/V 0V		3095	4120	pF
C _{oss}	Output Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		460	615	pF
C _{rss}	Reverse Transfer Capacitance			15	25	pF
R _q	Gate Resistance		0.1	1.6	3.3	Ω
0	Characteristics	1		1		
t _{d(on)}	Turn-On Delay Time			19	35	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 13 A,		5.4	11	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		27	44	ns
t _f	Fall Time			4	10	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		42	58	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 5 V V _{DD} = 50 V,		22	31	nC
Q _{gs}	Gate to Source Charge	I _D = 13 A		13.5		nC
Q _{gd}	Gate to Drain "Miller" Charge			6.2		nC
Drain-Sou	urce Diode Characteristics					
	Source to Drain Diode Forward Voltage $\frac{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.1 \text{ A}}{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 13 \text{ A}}$	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.74	1.2	
V _{SD}		$V_{GS} = 0 V, I_S = 13 A$ (Note 2)		0.81	1.3	V
t _{rr}	Reverse Recovery Time			64	102	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 13 A, di/dt = 100 A/μs		102	164	nC

Notes: 1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



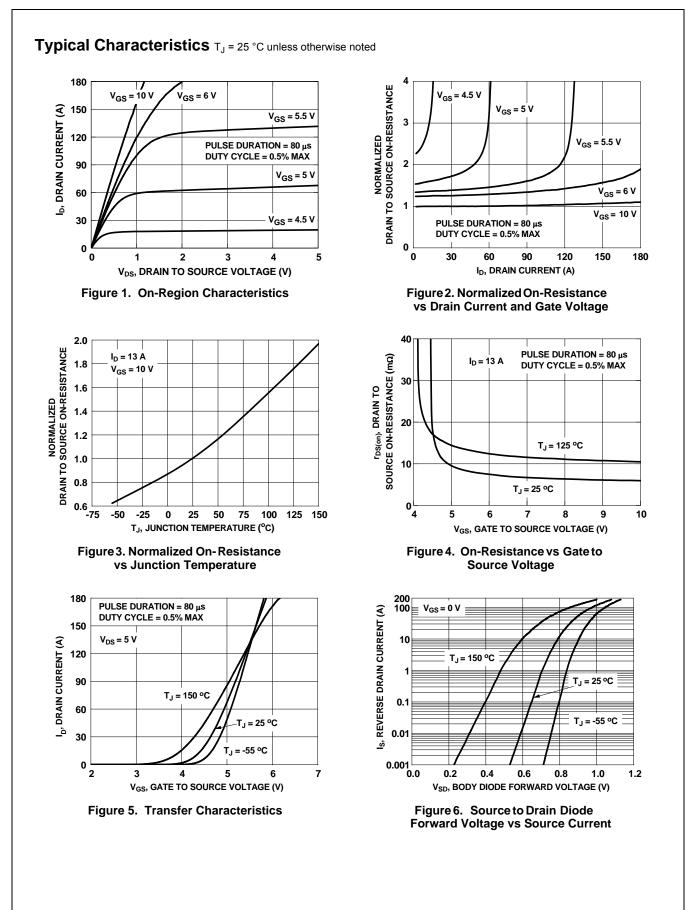




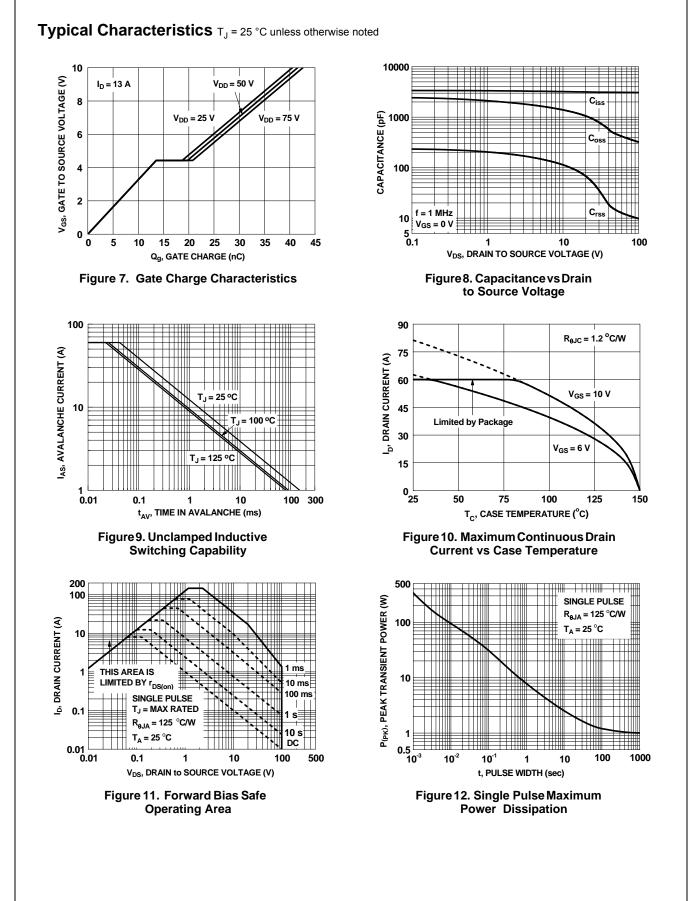
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

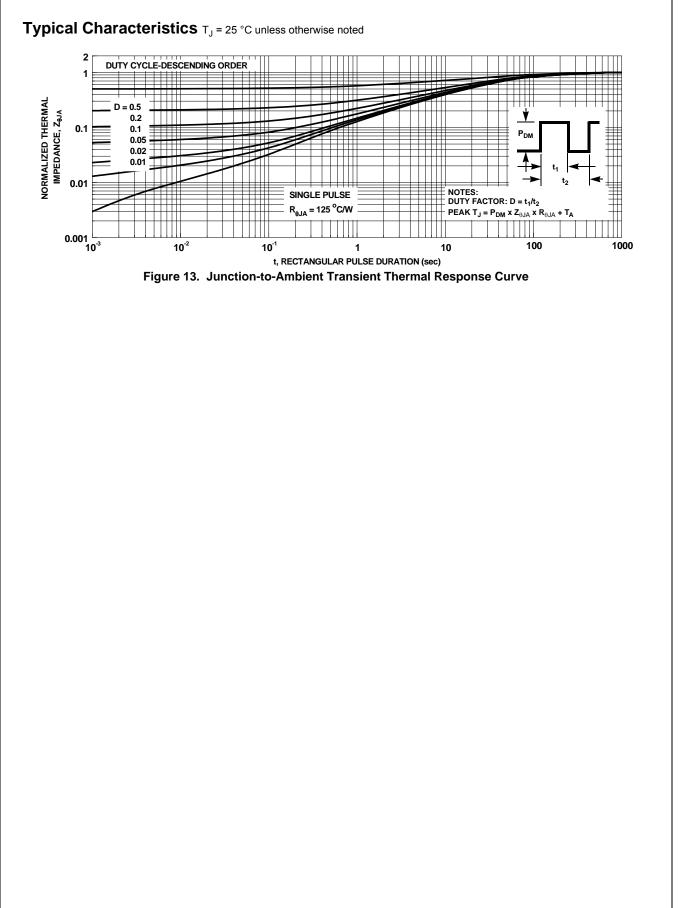
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. E_{AS} 486 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 18 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 51 A.

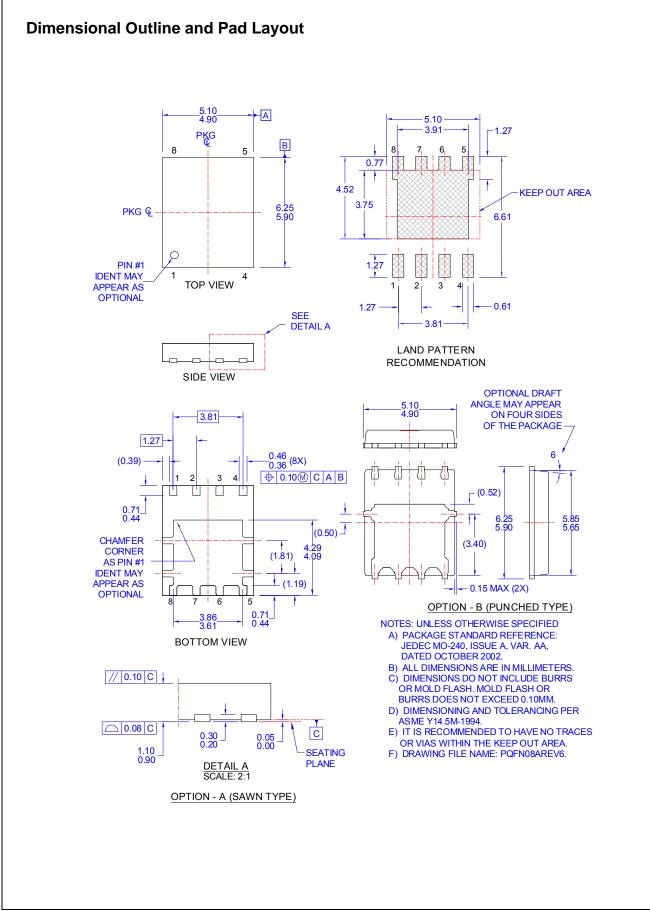








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Rev. 161

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